

Amendments to the Specification:

At page 1, line 1, please delete subheading:

~~Description~~

*Please amend the title to read as:*

METHOD FOR THE PRODUCTION OF SEMI-CONDUCTOR CHIPS

Please insert the following paragraph after the title:

CROSS-REFERENCE TO RELATED APPLICATIONS

This application is the National Stage of International Application No. PCT/DE2004/001329, filed June 24, 2004, which claims the benefit of German Patent Application Serial No. 103 28 543.1, filed on June 24, 2003. The contents of both applications are hereby incorporated by reference in their entireties.

*Please insert the following subheading immediately prior to the paragraph on page 1 beginning "The invention concerns...":*

FIELD OF THE INVENTION

*Please delete the second full paragraph on page 1, which starts with "The present patent application ..."*

*Please insert the following subheading immediately prior to the paragraph on page 1 beginning "One of the chief...":*

BACKGROUND OF THE INVENTION

*Please insert the following subheading immediately prior to the paragraph on page 2 beginning "The object of the present invention is...":*

Applicant : Georg Bruederl *et al.*  
Serial No. : To Be Assigned  
Filed : Herewith  
Page : 3 of 8

Attorney's Docket No.: 12406-143US1 / P2003,0394 US N

### SUMMARY OF THE INVENTION

*Please delete the second full paragraph on page 2, which starts with "This object is achieved by ...":*

*Please delete the third full paragraph on page 2, which starts with " Advantageous configurations of..."*

*Please insert the following subheading immediately prior to the paragraph on page 5 beginning "Further advantages, embodiments ...":*

### BRIEF DESCRIPTION OF THE DRAWINGS

*Please insert the following subheading immediately prior to the paragraph on page 5 beginning "In the method according ...":*

### DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS